# Effect of proton energy on damage generation in irradiated silicon

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Czochralski- and float-zone- grown silicon detectors were irradiated with 2 to 5 MeV protons. Capacitance-voltage (CV) measurements served to deduce the effective doping profiles and current-voltage (IV) measurements served to obtaining information on irradiation-induced deep levels. The CV measurements show that the proton-induced net space charge is positive or negative depending on the energy of the bombarding ion. The commonly employed nonionizing energy loss hypothesis was tested with the low energy proton regime and prominent previously unobserved deviations from predictions were noted. © 2010 American Institute of Physics. [doi:10.1063/1.3371714]

## I. INTRODUCTION

Various types of irradiations have been used over the years to study particle bombardment-induced effects on materials. Typically, the chosen irradiation energy has been sufficiently high to permit particles to pass through the detector, thus inducing nearly uniform defect distributions. In several of these irradiation experiments, which employ megaelectron-volt protons, researchers have observed a space charge sign inversion for initially n-type silicon. <sup>1-3</sup> However, in other studies, <sup>4,5</sup> the bombarding particles have stopped in the silicon material and high concentrations of positive space charge have been observed in the end-of-range region.

Many irradiation-induced defects are electrically active and fabricating a diodelike structure (pn-junction) of the material to be studied makes defect-related studies of silicon feasible with, for example, deep-level transient spectroscopy as well as capacitance-voltage (CV) and current-voltage (IV) techniques. The IV method is sensitive only to defects with levels close to the mid-band gap. In the present study, CV measurements are feasible upto a bias of 600 V. This enables the full depletion of a reverse-biased diode structure processed from commonly available silicon wafers (thickness  $\sim\!300~\mu\mathrm{m}$ , resistivity  $>\!1~\mathrm{k}\Omega$ ), which thereby allows irradiations with higher-energy protons penetrating deeper into the detector. The depth-sensitive CV method is combined with IV data to enable the determination of heterogeneous current-related damage distributions.

Current-related damage induced by particle bombardment is usually scaled to other irradiation environments by using the nonionizing energy loss (NIEL) hypothesis. We aimed to determine the sign of the net space charge of the induced major defects and to test the applicability of the NIEL hypothesis at relatively low energies by irradiating detectors made from Czochralski (Cz)- and float-zone (Fz)-grown silicon with 2 to 5 MeV protons.

## **II. MATERIALS AND EXPERIMENTS**

To study irradiation-induced defects in silicon with the capacitance-voltage and current-voltage methods, detectors

with diode structure  $(p^+/n^-/n^+)$  were fabricated from n-type, 300- $\mu$ m thick, Cz-grown (Cz-Si, resistivity ~1 k $\Omega$  cm) and Fz-grown (Fz-Si, resistivity  $\sim 10~\text{k}\Omega$  cm) materials supplied by Okmetic Ltd and Topsil, respectively. The detectors were processed at the Microelectronics Center of the Helsinki University of Technology. The thickness of the boron-implanted  $p^+$  layer was about 3.5  $\mu m$  and that of the phosphorusimplanted  $n^+$  layer was about 7  $\mu$ m. The front electrode was aluminum-sintered to a thickness of 0.5  $\mu$ m. The detector active area was  $5 \times 5$  mm<sup>2</sup> which was surrounded by 16 floating guard rings. A more detailed description of the detector structure is provided in Ref. 7. The current-voltage characteristics were determined with a Keithley 2410 SourceMeter Unit. The leakage current level at full depletion for all nonirradiated detectors was 30 to 100 nA. The capacitance-voltage characteristics were determined with a capacitance meter (frequency 18 kHz, maximum bias voltage 600 V) constructed especially for the measurement of diodes with a high leakage current. With the CV technique, a bulk donor concentration  $(N_D)$  of  $5.3 \times 10^{12}$  cm<sup>-3</sup> was noted for the non-irradiated Cz detectors. For the Fz detectors, the corresponding value was  $N_D = 5.1 \times 10^{11}$  cm<sup>-3</sup>.

The Cz detectors, two pieces per selected energy, were irradiated from p<sup>+</sup>-side with 2, 2.5, 3, 4, or 5 MeV protons and the Fz detectors with 2 or 2.5 MeV protons, respectively. The irradiations were performed using the 5 MV tandem accelerator of the Department of Physics, University of Helsinki. A detailed description of the irradiation facility used is provided in Refs. 8 and 9. Each detector was irradiated to the fluence of  $(5.0\pm0.5)\times10^{11}$  p/cm<sup>2</sup>. All irradiations and measurements were performed at room temperature  $(21.5\pm0.5\,^{\circ}\text{C})$ .

After irradiation, all detectors were annealed at room temperature for five days before making the CV and IV measurements. The CV curves measured for the irradiated Fz and Cz detectors are shown in Fig. 1(a), and typical IV curves in Fig. 1(b). The particles that stop in the detectors cause the levels noted in the CV curves, and the height of the level depends on the energy of the bombarding proton. In addition, as may be noted from Fig. 2, the width of the plateau depends on the irradiation fluence. Furthermore, clear changes

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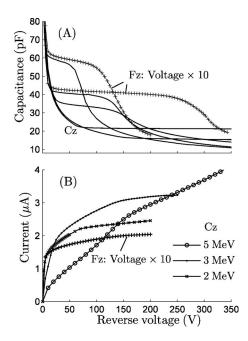


FIG. 1. (a) CV curves measured for Cz (solid lines) and Fz (lines with symbols) detectors after proton irradiation at various energies. The curves with the plateau at the highest capacitance value ( $\sim$ 60 pF) refer to 2 MeV irradiations and those having the plateau at the lowest value ( $\sim$ 16 pF) to 5 MeV irradiations. The curves in between correspond to 2.5, 3, and 4 MeV irradiations. For the sake of clarity, the voltage values of the Fz detectors (2 and 2.5 MeV irradiations) have been multiplied by a factor of 10. (b). Typical IV curves obtained after irradiation at selected energies. The curve for the Fz detector refers to a 2 MeV irradiation.

in the slopes of the IV curves perfectly match the plateau turning points in the corresponding CV curves.

### III. THEORETICAL CONSIDERATIONS

From the CV characteristics measured, one can determine the effective doping concentration  $(N_{\rm eff})$  as a function of depth at the low-doped side of the pn junction. <sup>10</sup> At the edge of the depletion region in the reverse-biased p<sup>+</sup>n junction, the effective doping concentration can be calculated from

$$N_{\text{eff}}(x) = \frac{2}{e\varepsilon_r \varepsilon_0} \left(\frac{dC_j^{-2}}{dV}\right)^{-1},\tag{1}$$

where e is the elementary charge,  $\varepsilon_r$  is the relative permittivity of silicon (the value adopted in this study was 11.7),  $\varepsilon_0$  is the permittivity of a vacuum,  $C_i$  is the junction capacitance

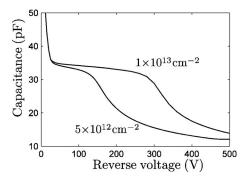


FIG. 2. The effect of irradiation fluence on CV curve plateau width. The material is Cz-grown silicon and the bombarding proton energy is 3 MeV.

per unit area, and V is the applied bias. The depletion layer width (x) is obtained simply from Eq. (2)

$$C_j(V) = \frac{\varepsilon_r \varepsilon_0}{x(V)}.$$
 (2)

The reverse current density  $J_R$  of an irradiated pn junction is the sum of four components, the diffusion current  $J_{\rm diff}$ , the current generated at the surface  $J_{sg}$ , the current  $J_g$  generated in the depleted layer, and the secondary ionization current  $J_{ii}$  at high reverse voltages. The diffusion current and the current generated at the surface can be eliminated by subtracting the IV curve measured prior to irradiation from the curve obtained after irradiation. The current must be subtracted relative to depth, thus correspondence between voltage and depth is required. This is obtained from the CV data by using Eq. (2). The component  $J_{ii}$  cannot be eliminated easily but fortunately it dominates only near the breakdown voltages.

The generation current strongly depends on the concentration of defects with deep energy levels (i.e., levels close to the mid-band gap). The defect concentration depends on the irradiation fluence and experimental results indicate that the following linear relationship between the generation current and fluence holds:<sup>6</sup>

$$\frac{\Delta I}{V} = \alpha \Phi_{neq},\tag{3}$$

where  $\Delta I$  is the current change in volume V,  $\alpha$  is the current-related damage rate, and  $\Phi_{neq}$  is the 1 MeV neutron equivalent irradiation fluence. Proton fluencies  $\Phi_p$  are scaled to a 1 MeV neutron equivalent fluence using hardness factor  $\kappa$  (i.e.,  $\Phi_{neq} = \kappa \Phi_p$ , NIEL scaling hypothesis<sup>6</sup>). Typically, Eq. (3) is used in situations where the bombarding energy of the incident particles is sufficient to enable penetration through the detector, thus resulting in nearly uniform defect distributions. There<sup>6</sup> are essentially no constraints on the proton energy in Eq. (3).

Using the depth information obtained from the CV data, the IV data enable us the opportunity to calculate the current density  $\mathrm{d}J_g$  generated in a layer  $\mathrm{d}x$  at the edge of the depletion area. Equation (3) may be expressed as

$$\frac{\mathrm{d}J_g}{\mathrm{d}x}\bigg|_{x} = \alpha(x)\kappa(x)\Phi_p. \tag{4}$$

Because the stopping power of silicon for protons is well established, <sup>11</sup> depth dependency may be converted to energy dependency.

On the other hand, the generation current density  $J_g$  in the depletion region of the p<sup>+</sup>n junction can be expressed as <sup>12</sup>

$$J_g = e \int_0^W G dx \cong \frac{e n_i W}{\tau_g}, \tag{5}$$

where G is the rate of electron-hole pair generation,  $n_i$  is the intrinsic carrier concentration, and  $\tau_g$  is the generation lifetime. For a thin layer dx, Eq. (5) yields

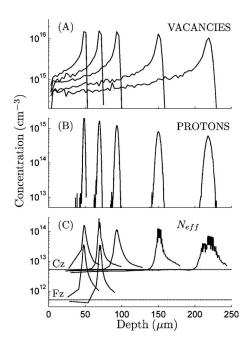


FIG. 3. Comparison of the calculated vacancy (a) and proton (b) depth profiles with the effective doping profiles (c) obtained from the CV data. The profiles refer to irradiation energies of 2, 2.5, 3, 4, and 5 MeV (from left to right). For each irradiation and calculation, the fluence has been  $5 \times 10^{11} \ \mathrm{p/cm^{-2}}$ . The horizontal dashed lines in the lowest graph indicate the doping levels  $(5.3 \times 10^{12} \ \mathrm{cm^{-3}}$  and  $5.1 \times 10^{11} \ \mathrm{cm^{-3}})$  prior to irradiation. Note that, for the Cz detectors, the  $N_{\mathrm{eff}}$  curves below the initial donor concentration level do not overlap and the lowest  $N_{\mathrm{eff}}$  value refers to the highest bombarding energy.

$$\frac{\mathrm{d}J_g}{\mathrm{d}x}\bigg|_x = \frac{en_i}{\tau_g(x)}.\tag{6}$$

The depth variable can be converted to energy E, as in the case of Eq. (4).

#### IV. RESULTS AND DISCUSSION

Applying Eqs. (1) and (2) to the measured CV data the depth profiles of  $N_{\rm eff}$  were extracted. The deduced profiles are shown in Fig. 3 and are compared in relation to the implanted proton and vacancy distributions obtained by the srim (Ref. 11) calculations. The inactive layer ( $\sim$ 4  $\mu$ m Si equivalent) in front of the depleted layer has been taken into account in defining the positions of the measured profiles.

According to Fig. 3, the effective doping profiles show no diminishing concentration tail when shifting from the profile peak toward the surface. Even if the  $N_{\rm eff}$  profiles are approximately twice as wide as the corresponding proton distributions, their shapes in general more closely match the vacancy profiles. It should be noted that the  $N_{\rm eff}$  profiles measured also feature deep-end tails extending beyond the end-of-range region, possibly due to the diffusion of defects resulting from the large concentration gradient at the deep-end side of the peak<sup>13</sup> or to bombarding proton channelling in silicon.

An important finding is that the concentrations of  $N_{\rm eff}$  close to the surface are lower than the donor concentration of the nonirradiated material. But deeper, near the end-of-range region, they are higher. For the Cz detectors the depth in silicon where the net space charge changes from negative to

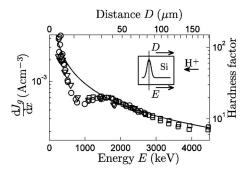


FIG. 4. Change in current density as a function of proton energy compared to relative damage concentration estimated by the NIEL scaling hypothesis (solid line, right axis). The results obtained from the data on the 5 MeV irradiations are shown by the squares, data on the 4 MeV irradiations as circles, and data on the 3 MeV irradiations as triangles. The distance *D* from the projected range value to the detector surface, as calculated by the SRIM code, is provided on the top axis and is explained in the inset.

positive, is about 40  $\mu$ m for 2.5 MeV,  $\sim$ 60  $\mu$ m for 3 MeV,  $\sim$ 110  $\mu$ m for 4 MeV, and  $\sim$ 170  $\mu$ m for 5 MeV irradiated detector. These values refer to a distance of 27 to 47  $\mu$ m from the end-of-range region toward the detector surface.

Some researchers have proposed that the change of the net space charge is caused mainly by the differing defect levels created in the end-of-range region and in the region closer to the detector surface. This assumption is in agreement with the findings of reference, where the mega-electron-volt proton-induced defects have been grouped into two categories, those created in the near surface region and those created near the end-of-range region.

The current density derivative  $\mathrm{d}J_g/\mathrm{d}x$  is proportional to  $\alpha(E)\kappa(E)$  and inversely proportional to the generation lifetime  $\tau_g$  [Eqs. (4) and (6)]. The  $\mathrm{d}J_g/\mathrm{d}x$  values measured as a function of proton energy are illustrated in Fig. 4 for the Cz material. For comparison, the NIEL scaling hypothesis (hardness factor  $\kappa$ ) and the vacancy production curve provided by the SRIM calculations are also shown. For Fz material, the depletion depth corresponding to the projected range is achieved by a bias voltage as low as 1 V [Fig. 1(a)], consequently, the  $\mathrm{d}J_g/\mathrm{d}x$  values are not presented.

As Fig. 4 shows, the NIEL scaling hypothesis and SRIM damage calculations agree well with the present experimental data for energies above 1700 keV but a clear discrepancy may be noted at lower energies. For energies above 1700 keV the value for the  $\alpha$  parameter is about 6  $\times 10^{-18}$  A cm<sup>-1</sup> assuming that the NIEL hypothesis is valid [Eq. (4)]. The current density derivative seems to saturate at energies between 1700 and 700 keV. The latter value corresponds to the end-of-range region of the bombarding protons. The transition point (1700 keV) is located at an approximate distance of 37  $\mu$ m from the projected range, which is in close agreement with the value noted for the position, in which the net space charge type changes. The saturation of the defect concentration noted<sup>15</sup> at the end-ofrange region, could also take place in a region closer to the detector surface. Moreover, we propose that the interaction of more complex defects and the recombination of electronhole pairs decrease the generated bulk current, which may lead to the noted observation. In composing Fig. 4, a constant fluence  $[(5.0\pm0.5)\times10^{11}~{\rm p/cm^2}]$  has been assumed at all depths. This assumption is not valid in regions less than 10  $\mu$ m from the projected range  $R_p$ , where a significant proportion of the protons have stopped (end-of-range region). Thus, the  ${\rm d}J_g/{\rm d}x$  is underestimated in the end-of-range region.

In this context, we have knowingly avoided the separation of the  $\alpha(E)\kappa(E)$  factor. As noted, for energies above 1700 keV, the NIEL scaling agrees with the measurements leading to the assumption that  $\alpha$  is the sole variable in Eq. (4). However, studies cited in Ref. 16 indicate that factor  $\kappa$  deviates from the NIEL predictions at higher proton energies (7–10 MeV), and others in Ref. 17 have noted deviations at lower energies also (100 keV < E < 6 MeV). The generation lifetime measurements carried out using the Zerbst technique (which is based on capacitance measurements) for 4 MeV proton-irradiated silicon have shown that the  $\tau_g$  behavior agrees with the SRIM defect calculations near the end-of-range region as well, which contradicts the present results shown in Fig. 4. In general, the main problem in studying the hardness factor is the varying array of methods used. 19

#### V. CONCLUDING REMARKS

This paper reports our findings on the damage profiles in silicon caused by MeV proton bombardment. The effective doping concentration profiles have been measured with the CV method and the current-related damage was studied with the IV technique. The resulting defects can be categorized into two main groups, defects with net negative space charge induced by protons with energies above 1700 keV and defects with positive net space charge induced by lower-energy protons. In addition, the (hydrogen-related) end-of-range defects could be distinguished from the defects with positive charge. In the p-type region the creation of current-related damage follows well the predictions of the empirical model [Eq. (3)]. However, in the n-type region, the production of damage seems to saturate with a high concentration of current-related damage created prior to the end-of-range region. The probable main causes of the noted phenomena are the energy dependency of the type of the net space charge generated and the interactions of the defects.

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